

FFM101 thru FFM107

FEATURES

- * Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- * High temperature metallurgically bonded construction
- * Cavity-free glass passivated junction
- * Capable of meeting environmental standards of MIL-S-19500
- * Fast Switching for high efficiency
- * Typical IR less than 1.0μA
- * High temperature soldering guaranteed: 260°C/10 seconds

Mechanical Data

Case: JEDEC DO-214AC, molded plastic over glass body

Terminals: Plated axial leads, solderable per MIL-STD-750, Method 2026

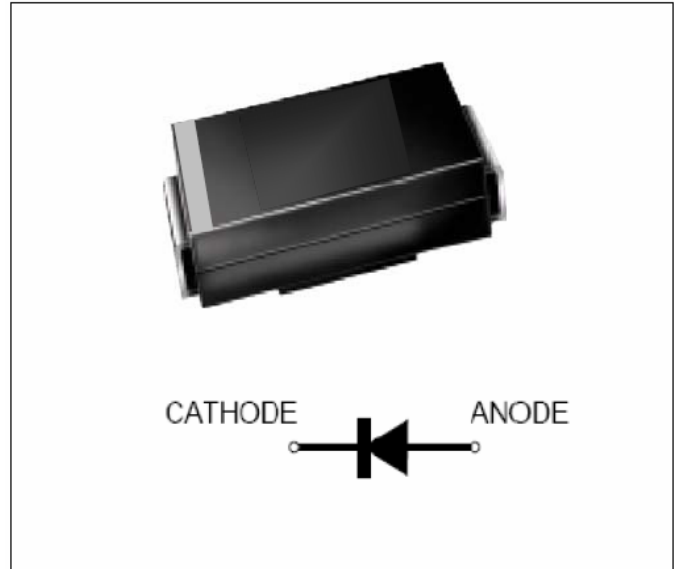
Polarity: Color band denotes cathode end

Mounting Position: Any

Weight: 0.002 oz., 0.061 g

Handling precaution: None

Surface Mount Glass Passivated Junction Fast Recovery
Reverse Voltage 50 to 1000V
Forward Current 1.0A



We declare that the material of product compliance with RoHS requirements.

Maximum Ratings & Thermal Characteristics Ratings at 25°C ambient temperature unless otherwise specified.

Parameter Symbol	symbol	FFM 101	FFM 102	FFM 103	FFM 104	FFM 105	FFM 106	FFM 107	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current 0.375" (9.5mm) lead length at $T_A = 75^\circ C$	$I_{F(AV)}$	1.0							A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	30							A
Typical thermal resistance (Note 2)	$R_{\theta JA}$	75							°C/W
Operating junction and storage temperature range	T_J, T_{STG}	-50 to +150							°C

Electrical Characteristics Ratings at 25°C ambient temperature unless otherwise specified.

Parameter Symbol	symbol	FFM 101	FFM 102	FFM 103	FFM 104	FFM 105	FFM 106	FFM 107	Unit
Maximum instantaneous forward voltage at 1.0A	V_F	1.3							V
Maximum DC reverse current $T_A = 25^\circ C$ at rated DC blocking voltage $T_A = 125^\circ C$	I_R	5.0 100							μA
Typical reverse recovery time (Note 1)	t_{rr}	150					500		ns
Typical junction capacitance at 4.0V, 1MHz	C_J	8.0							PF

NOTES:

1. $I_F = 0.5A, I_R = 1.0A, I_{RR} = 0.25A$
2. Thermal resistance from junction to ambient at 0.375" (9.5mm) lead length, P.C.B. mounted

Ratings and Characteristic Curves (TA = 25°C unless otherwise noted)

Fig. 1 - Forward Current Derating Curve

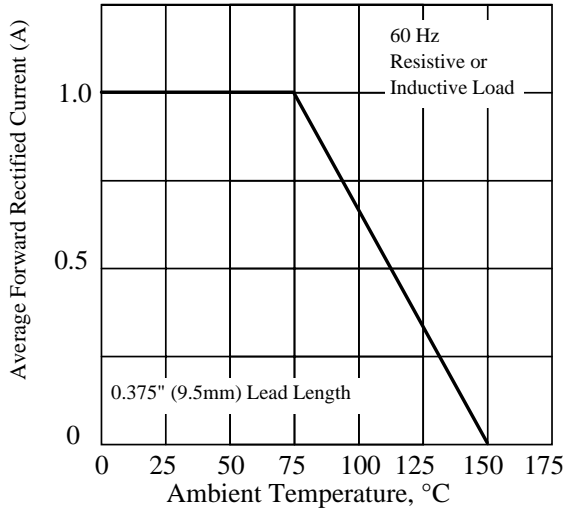


Fig. 2 - Maximum Non-repetitive Peak Forward Surge Current

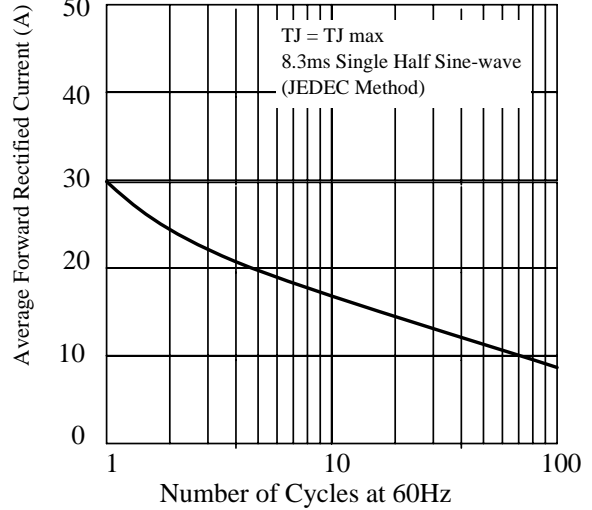


Fig 3. - Typical Instantaneous Forward Characteristics

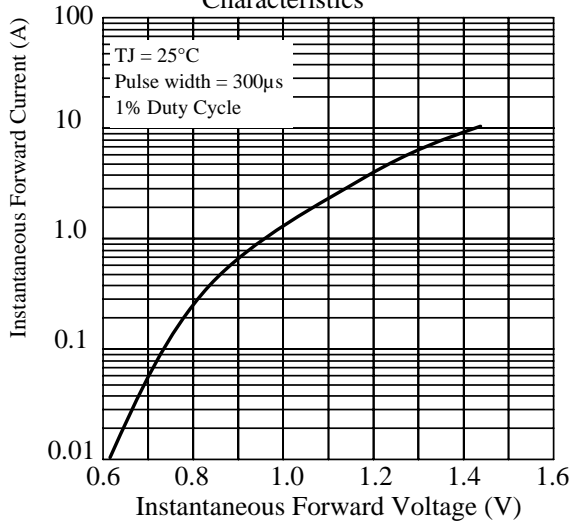


Fig 4. - Typical Reverse Characteristics

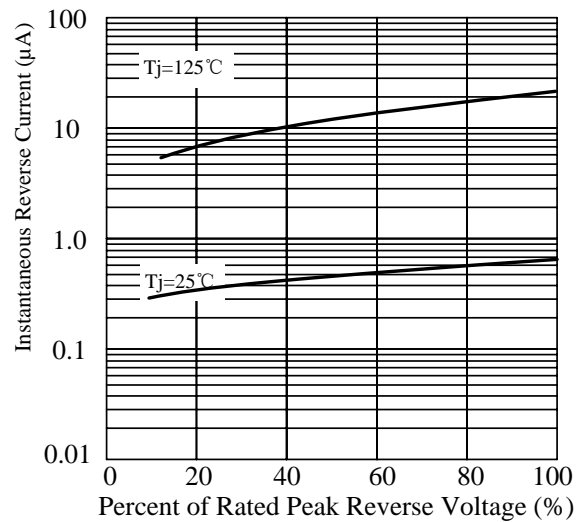


Fig 5. - typical transient thermal impedance

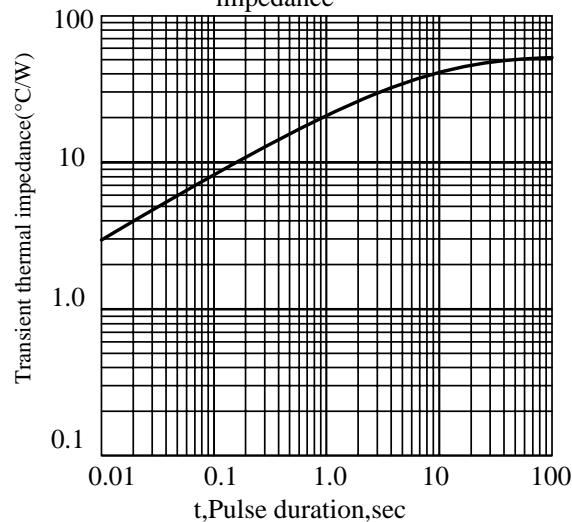
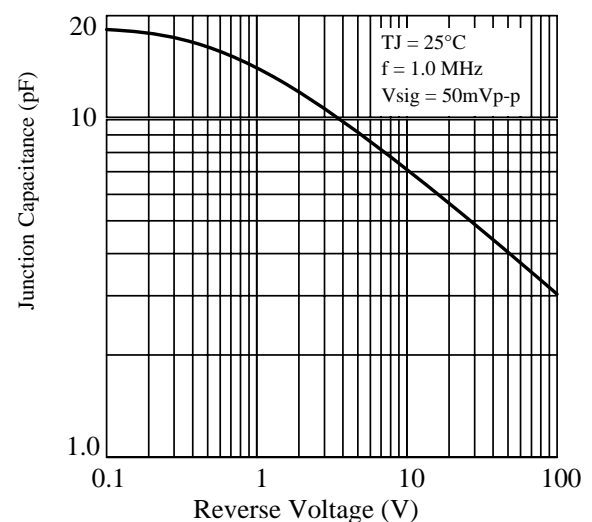
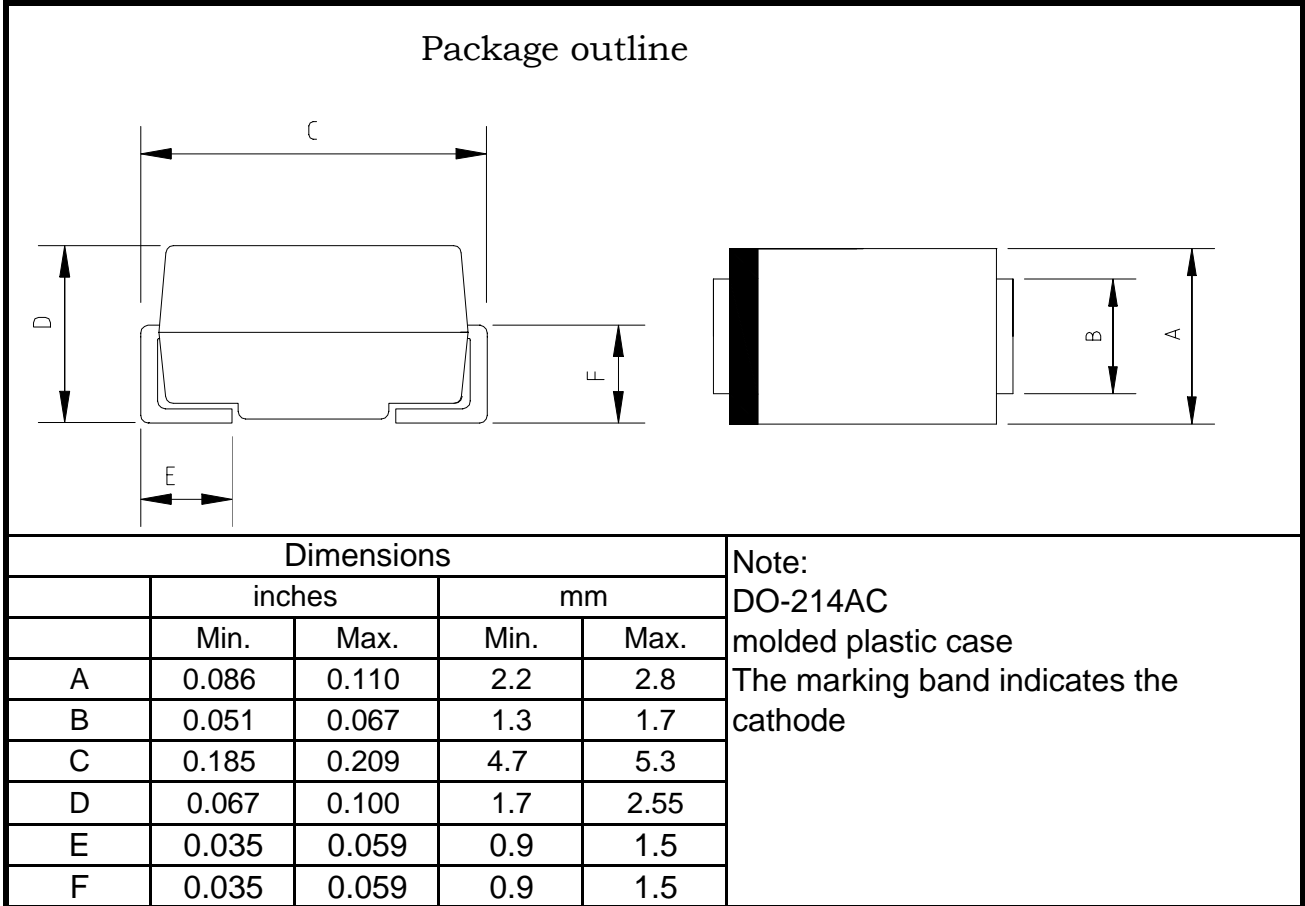


Fig 6. - Typical Junction Capacitance

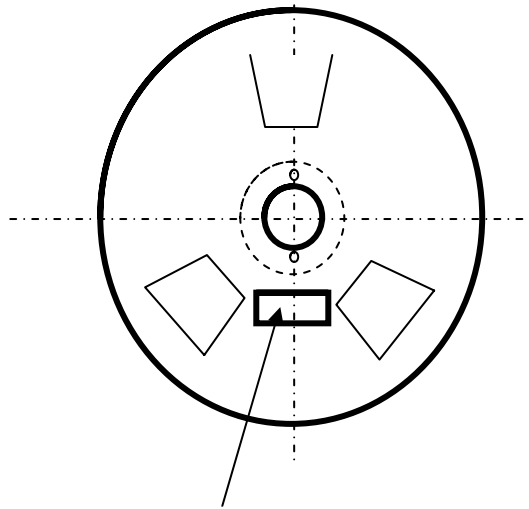


Package Dimensions in inches and (millimeters)



SMA Packing Specification

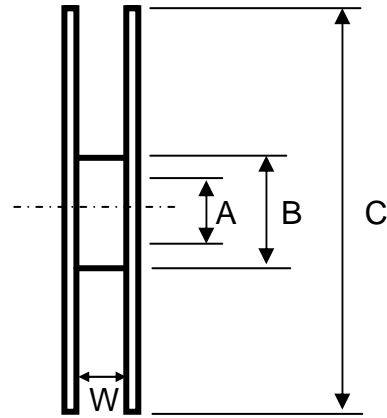
1. 卷盘规格/Reel Packing



Label stike this position

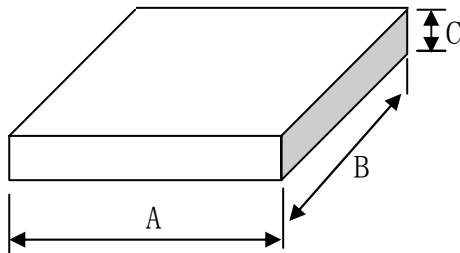
Item	Q'ty/Taping
7"	2K
13"	5K

Unit:mm



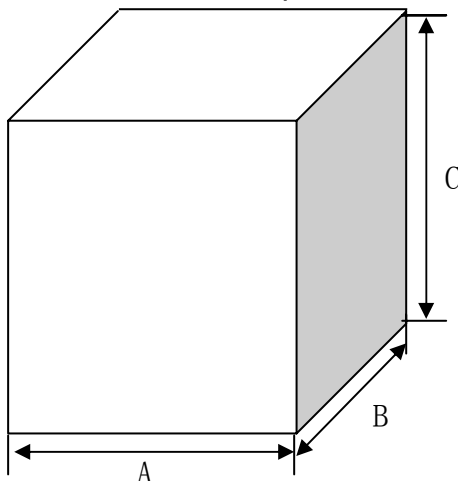
Item	Symbol	Dimension
13" Size	A	13.0±0.2
	B	75.0±0.5
	C	330±1.0
	W	13.2±1.0
7" Size	A	13.0±0.2
	B	54±0.5
	C	177±1.0
	W	13.2±1.0

2. 内箱规格/ Inside Box Specification



Item	Symbol	Dimension
Size	A	335±2
	B	335±2
	C	40±1

3. 外箱规格/Outer Box Specification



Item	Symbol	Dimension
Size	A	350±2
	B	350±2
	C	345±2

单击下面可查看定价，库存，交付和生命周期等信息

[>>LRC\(乐山无线电\)](#)